S1A thru S1M

Vishay General Semiconductor

Surface Mount Glass Passivated Rectifier

DO-214AC (SMA)

PRIMARY CHARACTERISTICS	
$I_{F(AV)}$	1.0 A
V_{RRM}	50 V to 1000 V
I_{FSM}	40 A, 30 A
E_{AS}	5 mJ
I_R	1.0 µA, 5.0 µA
V_F	1.1 V
T_J max.	150 °C

TYPICAL APPLICATIONS

For use in general purpose rectification of power supplies, inverters, converters and freewheeling diodes for consumer, automotive and telecommunication.

FEATURES

- Low profile package
- Ideal for automated placement
- Glass passivated chip junction
- Low forward voltage drop
- Low leakage current
- High forward surge capability
- Meets MSL level 1, per J-STD-020, LF maximum peak of 260 °C
- Compliant to RoHS Directive 2002/95/EC and in accordance to WEEE 2002/96/EC
- **Halogen-free according to IEC 61249-2-21 definition**

RoHS COMPLIANT
HALOGEN FREE

MECHANICAL DATA

Case: DO-214AC (SMA)
Molding compound meets UL 94 V-0 flammability rating
Base P/N-M3 - halogen-free, RoHS compliant, and commercial grade

Terminals: Matte tin plated leads, solderable per J-STD-002 and JESD 22-B102
M3 suffix meets JESD 201 class 1A whisker test

Polarity: Color band denotes cathode end

MAXIMUM RATINGS (T_A = 25 °C unless otherwise noted)

PARAMETER	SYMBOL	S1A	S1B	S1D	S1G	S1J	S1K	S1M	UNIT
Device marking code		SA	SB	SD	SG	SJ	SK	SM	
Maximum recurrent peak reverse voltage	V_{RRM}	50	100	200	400	600	800	1000	V
Maximum RMS voltage	V_{RMS}	35	70	140	280	420	560	700	V
Maximum DC blocking voltage	V_{DC}	50	100	200	400	600	800	1000	V
Maximum average forward rectified current (fig. 1)	$I_{F(AV)}$	1.0							A
Peak forward surge current 8.3 ms single half sine-wave superimposed on rated load	I_{FSM}	40					30		A
Non-repetitive peak reverse avalanche energy at 25 °C, I_{AS} = 1 A, L = 10 mH	E_{AS}	5							mJ
Operating junction and storage temperature range	T_J, T_{STG}	- 55 to + 150							°C

For technical questions within your region, please contact one of the following:
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S1A thru S1M

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ELECTRICAL CHARACTERISTICS (T_A = 25 °C unless otherwise noted)											
PARAMETER	TEST CONDITIONS		SYMBOL	S1A	S1B	S1D	S1G	S1J	S1K	S1M	UNIT
Maximum instantaneous forward voltage	1.0 A		V_F	1.1							V
Maximum DC reverse current at rated DC blocking voltage		T_A = 25 °C	I_R	1.0					5.0		μA
		T_A = 125 °C		50							
Typical reverse recovery time	I_F = 0.5 A, I_R = 1.0 A, I_{rr} = 0.25 A		t_{rr}	1.8							μs
Typical junction capacitance	4.0 V, 1 MHz		C_J	12							pF

THERMAL CHARACTERISTICS (T_A = 25 °C unless otherwise noted)									
PARAMETER	SYMBOL	S1A	S1B	S1D	S1G	S1J	S1K	S1M	UNIT
Typical thermal resistance (1)	$R_{\theta JA}$	75					85		°C/W
	$R_{\theta JL}$	27					30		

Note

(1) Thermal resistance from junction to ambient and from junction to lead mounted on PCB with 0.2" x 0.2" (5.0 mm x 5.0 mm) copper pad areas

ORDERING INFORMATION (Example)				
PREFERRED P/N	UNIT WEIGHT (g)	PREFERRED PACKAGE CODE	BASE QUANTITY	DELIVERY MODE
S1J-M3/61T	0.064	61T	1800	7" diameter plastic tape and reel
S1J-M3/5AT	0.064	5AT	7500	13" diameter plastic tape and reel

RATINGS AND CHARACTERISTICS CURVES

(T_A = 25 °C unless otherwise noted)

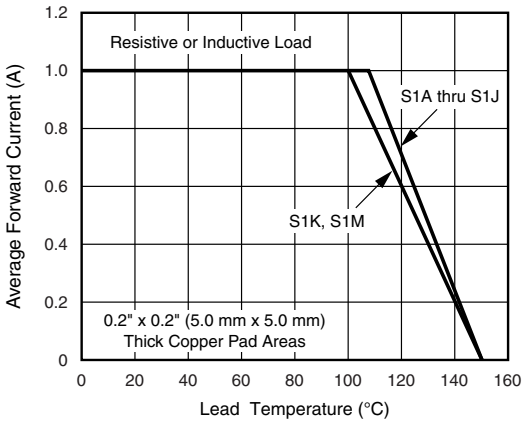

Fig. 1 - Forward Current Derating Curve

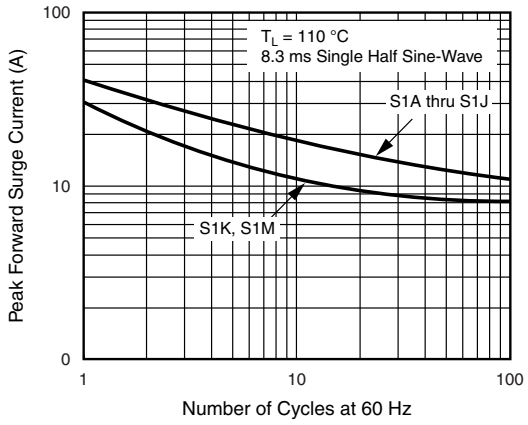

Fig. 2 - Maximum Non-Repetitive Peak Forward Surge Current

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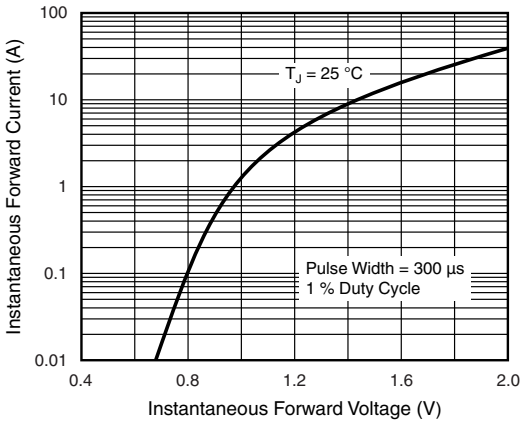


Fig. 3 - Typical Instantaneous Forward Characteristics

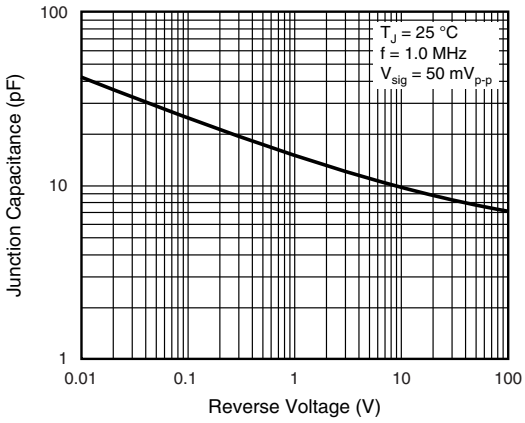


Fig. 5 - Typical Junction Capacitance

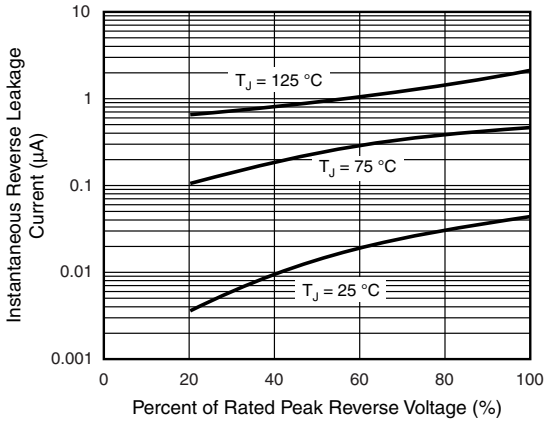


Fig. 4 - Typical Reverse Leakage Characteristics

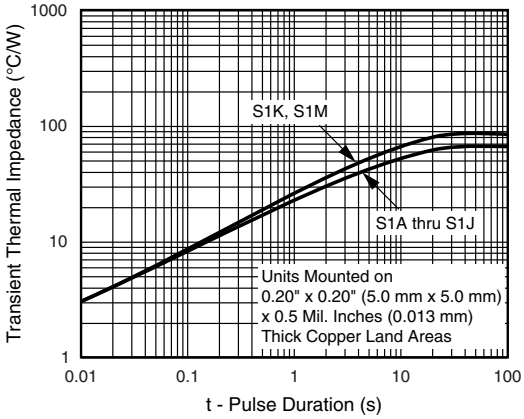
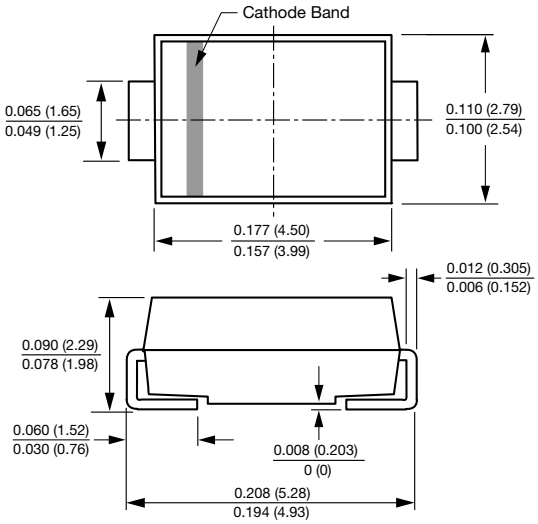


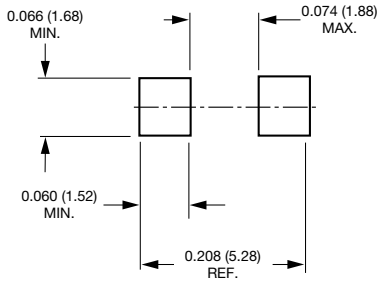
Fig. 6 - Typical Transient Thermal Impedance

PACKAGE OUTLINE DIMENSIONS in inches (millimeters)

DO-214AC (SMA)



Mounting Pad Layout



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